

20V Dual N-Channel Mosfet

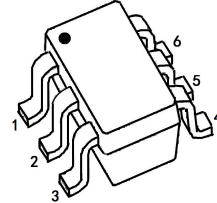
FEATURES

- $R_{DS(ON)} \leq 21.5m\Omega$ (19.8m Ω Typ.)
@ $V_{GS}=4.5V$
- $R_{DS(ON)}=27.5m\Omega$ (24.0m Ω Typ.)
@ $V_{GS}=2.5V$

APPLICATIONS

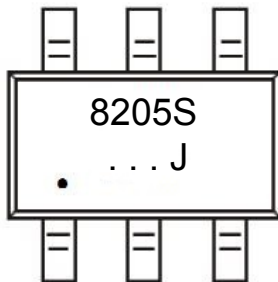
- Load Switch for Portable Devices
- Battery Protection
- Power Management

SOT-23-6L

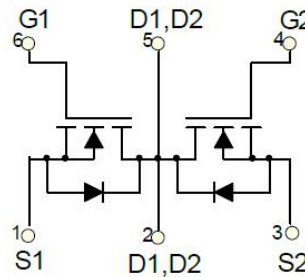


- 1: S1 3: S2 5: D1/D2
2: D1/D2 4: G2 6: G1

MARKING



N-CHANNEL MOSFET



MAXIMUM RATINGS (Ta=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 12	
I_D	Continuous Drain Current	4.8	A
I_{DM}	Pulsed Drain Current	12	
P_D	Maximum Power Dissipation	1.25	W
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient(t \leq 5s)	357	$^{\circ}C/W$
T_J	Junction Temperature	150	$^{\circ}C$
T_{stg}	Storage Temperature	-55 ~+150	

MOSFET ELECTRICAL CHARACTERISTICS Ta=25 °C unless otherwise specified

Symbol	Parameter	Test Condition	Min	Typ	Max	Units
Static						
V _{(BR)DSS}	Drain-source breakdown voltage	V _{GS} = 0V, I _D =250μA	20	21.6		V
V _{GS(th)}	Gate-source threshold voltage	V _{DS} =V _{GS} , I _D =250μA	0.5	0.72	1.0	
I _{GSS}	Gate-source leakage	V _{DS} =0V, V _{GS} =±12V			±100	nA
I _{DSS}	Zero gate voltage drain current	V _{DS} =19V, V _{GS} =0V			1	μA
R _{DS(on)}	Drain-source on-state resistance note1	V _{GS} =4.5V, I _D =4.8A		19.8	21.5	mΩ
		V _{GS} =2.5V, I _D =4A		24	27.5	
V _{SD}	Body diode voltage	I _S =1.7A		0.8	1.2	V
Dynamic note2						
C _{iss}	Input capacitance	V _{DS} =8V, V _{GS} =0V f =1MHz		600		pF
C _{oss}	Output capacitance			330		
C _{rss}	Reverse transfer capacitance			140		
Q _g	Total gate charge	V _{DS} =10V, V _{GS} =4.5V I _D =4A		11		nC
Q _{gs}	Gate-source charge			2.3		
Q _{gd}	Gate-drain charge			2.5		
t _{d(on)}	Turn-on delay time	V _{DS} =10V, I _D =1A, V _{GS} =4V, R _{GEN} =10Ω		18		nS
t _r	Rise time			5		
t _{d(off)}	Turn-off delay time			43		
t _f	Fall time			20		

Notes: 1. Pulse Test : Pulse Width < 300μs, Duty Cycle ≤2%.

2. Guaranteed by design, not subject to production testing.

N-Channel 20V (D-S) MOSFET Typical Characteristics

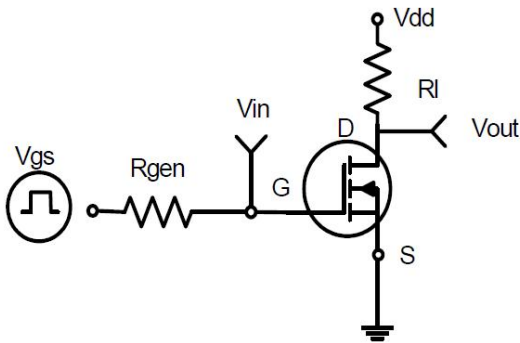


Figure 1: Switching Test Circuit

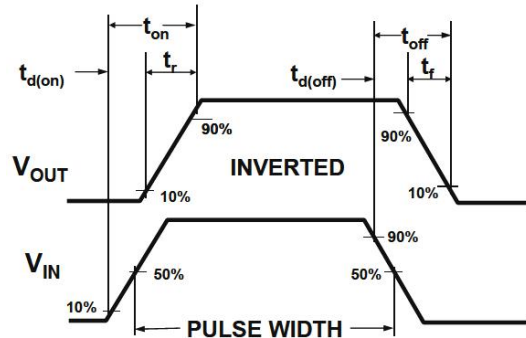


Figure 2: Switching Waveforms

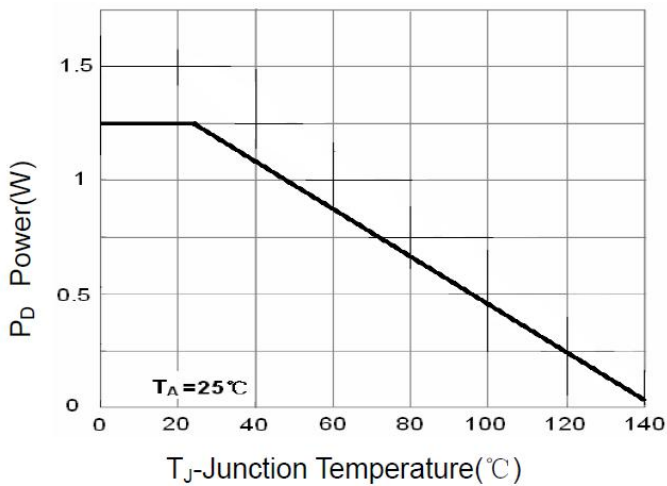


Figure 3 Power Dissipation

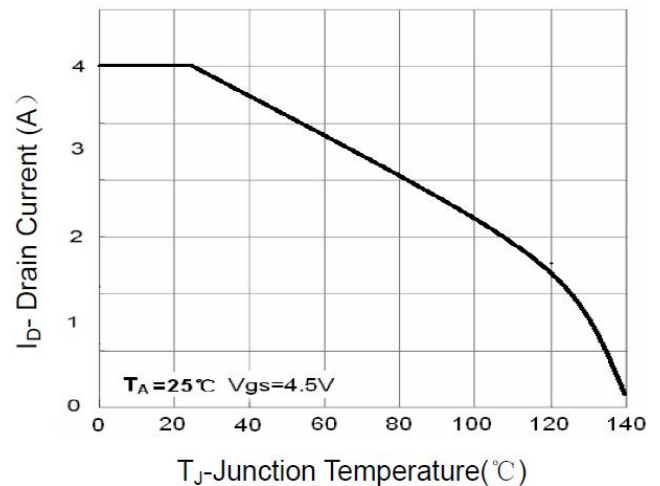


Figure 4 Drain Current

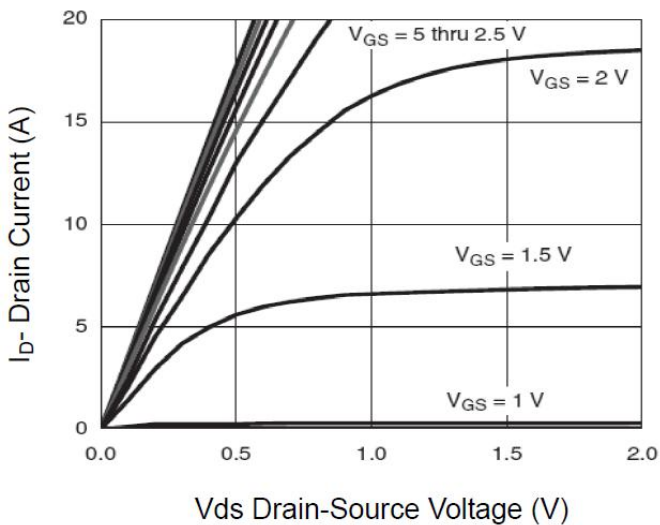


Figure 5 Output Characteristics

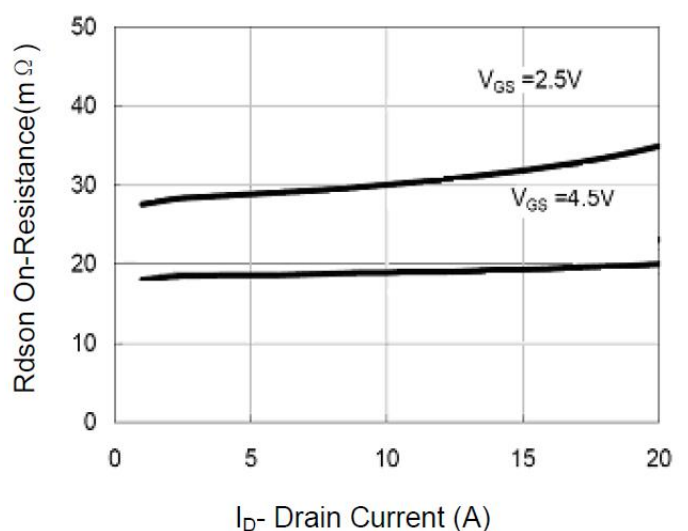


Figure 6 Drain-Source On-Resistance

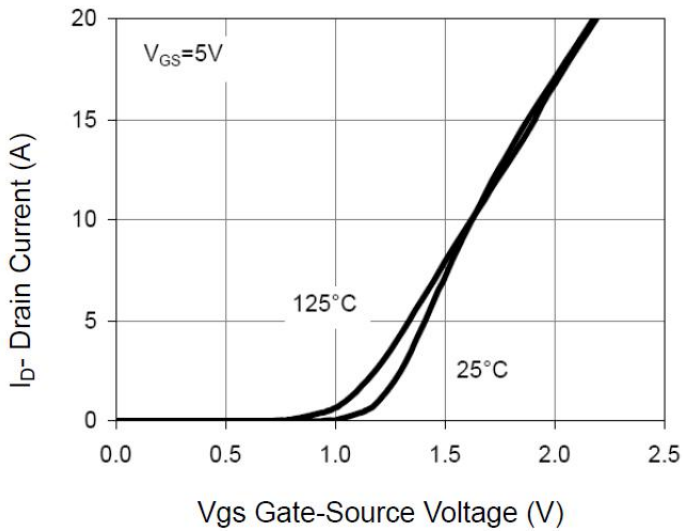


Figure 7 Transfer Characteristics

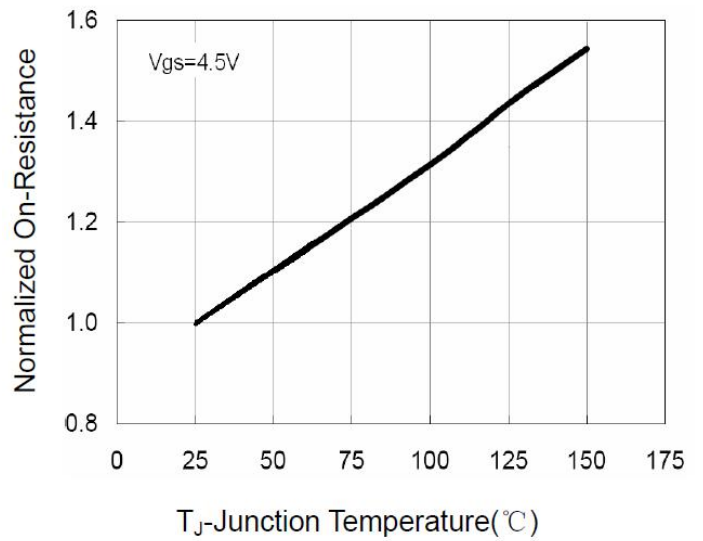


Figure 8 Drain-Source On-Resistance

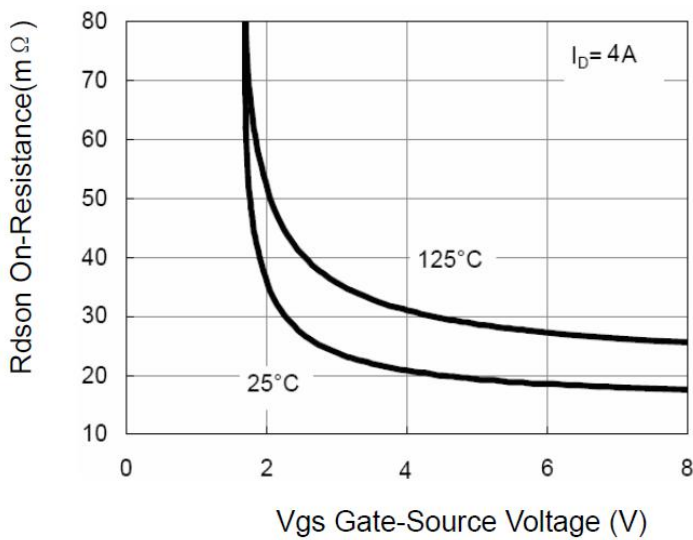


Figure 9 Rdson vs Vgs

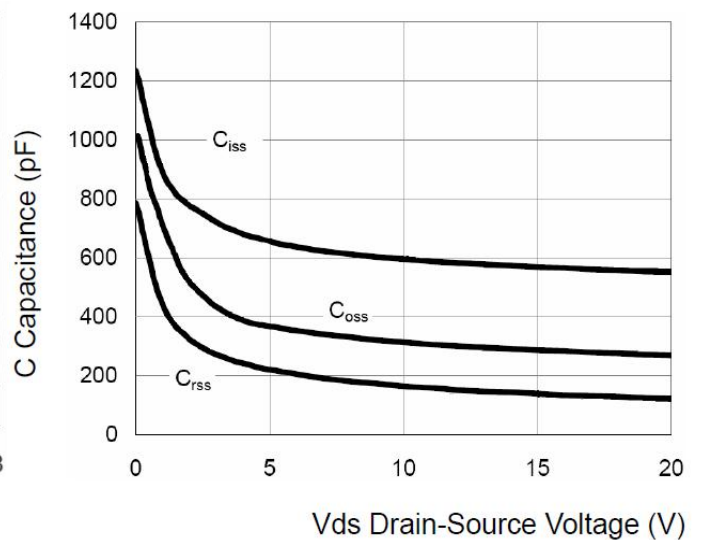


Figure 10 Capacitance vs Vds

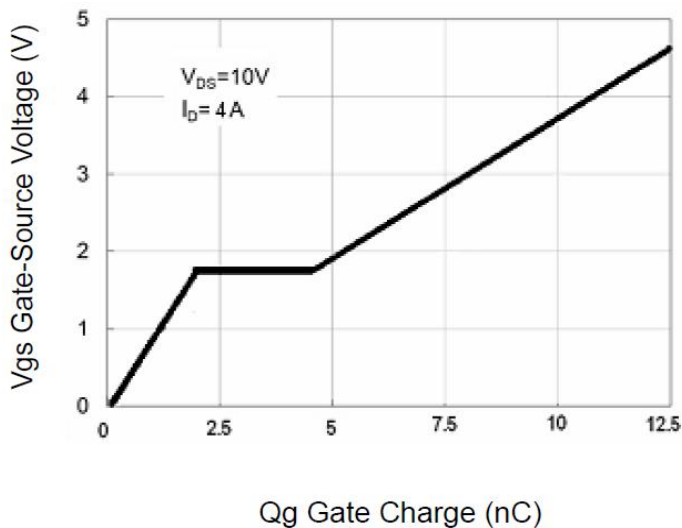
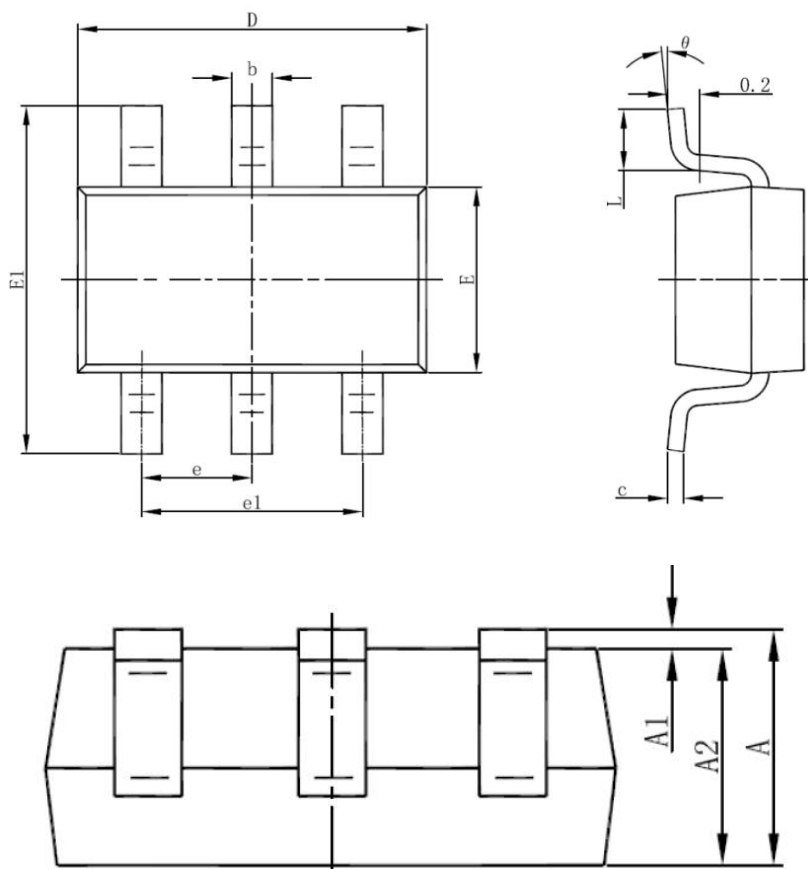


Figure 11 Gate Charge

SOT-23-6L PACKAGE OUTLINE DRAWING



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°